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## **General Description**

The MAX6513 is a fully integrated, remote temperature switch that uses an external P-N junction (typically a diode-connected transistor) as the sensing element to measure the remote temperature. The device asserts a logic signal when the temperature crosses a factoryprogrammed threshold. Available trip thresholds are from +45°C to +125°C in 10°C increments. Accuracy is within  $\pm 3^{\circ}C$  (TA = -5°C to +55°C) or  $\pm 5^{\circ}C$  (TA = -40°C to +85°C). Hysteresis is pin selectable to 5°C or 10°C.

The MAX6513 has an active-high CMOS output. The output is asserted when the temperature exceeds the threshold value. The active-high CMOS output can directly drive a power FET to control a cooling fan.

The MAX6513 operates from a +3.0V to +5.5V supply and typically consumes 400µA of supply current. It is available in a 6-pin lead-free TDFN package.

> CPU Temperature Monitoring in High-Speed Computers **Multichip Modules Battery Packs Temperature Control Temperature Alarms** Fan Control

Applications

### Features

- Continuously Measure External Junction Temperature
- Factory-Programmed Temperature Threshold from +45°C to +125°C in 10°C Increments

- Insensitive to Series Parasitic Resistance
- Active-High Output for Direct Fan Control
- < 100ms Response Time</p>
- Accuracy ±3°C (TREMOTE = +45°C to +125°C, TA = -5°C to +55°C)  $\pm$ 5°C (T<sub>REMOTE</sub> = +45°C to +125°C, T<sub>A</sub> = -40°C to +85°C)
- Pin-Selectable 5°C or 10°C Hysteresis
- 400µA Average Current Consumption
- +3.0V to +5.5V Supply Range
- ♦ 6-Pin TDFN Package (Lead(Pb)-Free) with **Exposed Pad**

## **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE	
MAX6513TT +T	-40°C to +85°C	6 TDFN-EP*	

Note: These parts are offered in nine standard temperature versions with a minimum order of 2500 pieces. To complete the suffix information, select an available trip point in degrees centigrade from the device marking codes table. For example, the MAX6513TT065+T describes a MAX6513 in a 6-pin TDFN package with a +65°C threshold.

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

\*EP = Exposed pad.

## **Typical Operating Circuit**



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## **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage (VDD)	-0.3V to +6V
DXP, DXN, HYST, TOVER	0.3V to (V <sub>DD</sub> + 0.3V)
TOVER Output Current	1mA/+50mA
DXN Input Current	1mA/+50mA
Current (all other pins)	±20mA
Continuous Power Dissipation (T <sub>A</sub> = +70°	C)
TDFN (derate 18.2mW/°C above +70°C	c)1455mW

Operating Temperature Range	40°C to +85°C
Storage Temperature Range	65°C to +150°C
Junction Temperature	+150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS**

(V<sub>DD</sub> = +3.0V to +5.5V, C<sub>S</sub> = 2200pF, T<sub>A</sub> = -40°C to +85°C, T<sub>REMOTE</sub> = +45°C to +125°C (Note 1), unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS	
Supply Voltage Range	V <sub>DD</sub>		3.0		5.5	V	
Supply Current	IDD			400	600	μA	
Temperature Threshold	ΔΤτΗ	$T_A = -5^{\circ}C \text{ to } +55^{\circ}C$	-3.0		+3.0	°C	
Accuracy (Note 3)		$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$	-5.0		+5.0		
Power-Supply Sensitivity for Temperature Trip Point				-0.6		°C/V	
Temperature Threshold	Тихот	$HYST = V_{IL}$		5		•	
Hysteresis	THYSI	$HYST = V_{IH}$		10			
Response Time				70	120	ms	
Input Voltage High	VIH		V <sub>DD</sub> - 0.2			V	
Input Voltage Low	VIL				0.2	V	
Output Voltage High	VOH	I <sub>OUT</sub> = 1mA	V <sub>DD</sub> - 0.2			V	
Output Voltage Low	VOL	I <sub>OUT</sub> = 1mA			0.2	V	
Maximum DXP Source Current		$0.4V \le V_{DXP} \le 2V,$ DXN = GND		270		μA	
Minimum DXP Source Current		$0.4V \le V_{DXP} \le 2V,$ DXN = GND		9		μA	

**Note 1:**  $T_{REMOTE}$  refers to the temperature of the remote-sensing junction.  $T_A$  refers to the temperature of the MAX6513 package. **Note 2:** All parameters are 100% production tested at  $T_A = +25^{\circ}$ C. Specifications over temperature limits are guaranteed by design. **Note 3:** This parameter is guaranteed by design to ±3.5 sigma.



 $(V_{DD} = +3.3V, C_S = 2200pF, T_A = +25^{\circ}C, unless otherwise noted.)$ 



TEMPERATURE TRIP THRESHOLD ERROR vs. SERIES RESISTANCE

TEMPERATURE TRIP THRESHOLD vs. SUPPLY VOLTAGE





#### PIN NAME FUNCTION Power-Supply Input, +3.0V to 1 +5.5V. Bypass VDD to GND with VDD a 0.1µF capacitor. 2 GND Ground Hysteresis Selection. Hysteresis 3 HYST is 10°C for HYST = Vnn. 5°C for HYST = GND. CMOS Active-High Output. TOVER goes high when the TOVER temperature exceeds the factory-Δ programmed temperature threshold. This pin connects to the negative (cathode) terminal of 5 DXN the external P-N sense junction. DXN must be connected to GND. This pin connects to the positive 6 DXP (anode) terminal of the external P-N sense junction. Exposed Pad. Not internally EΡ connected. Connect to GND or leave unconnected.

## **Pin Description**

## **Detailed Description**

The MAX6513 fully integrated temperature switch incorporates a precision bandgap reference, a conversion block, a current source, and a comparator (Figure 1). The device uses an external P-N junction as the temperature-sensing element. It steers bias currents through the external diode, measures the forward voltages, and computes the temperature using a precision chopper stabilized amplifier.

Resistance values of less than  $100\Omega$  in series with the external sense junction will result in trip-point errors < 1°C. The MAX6513 provides noise immunity by integration and oversampling of the diode voltage, but good design practice includes routing the DXP and DXN lines away from noise sources, such as high-speed digital lines, switching regulators, inductors, and transformers. The DXP and DXN traces should be paired together and surrounded by ground plane whenever possible.

In applications where the temperature changes rapidly, the measured temperature will be approximately equal to the average value of the temperature during the measurement period.

The MAX6513 has an active-high CMOS output, and is available with preset temperature thresholds from  $+45^{\circ}$ C to  $+125^{\circ}$ C in 10°C increments.



Figure 1. Functional Block Diagram

MANUFACTURER	MODEL NUMBER		
Central Semiconductor (USA)	CMPT3904		
ON (USA)	MMBT3904		
Rohm Semiconductor (Japan)	SST3904		
Samsung (Korea)	KST3904-TF		
Siemens (Germany)	SMBT3904		
Zetex (England)	FMMT3904CT-ND		

### **Table 1. Sensor Transistor Manufacturers**

*Note:* Transistors must be diode connected (base shorted to collector).

### **Hysteresis Input**

The HYST pin is a CMOS-compatible input that selects hysteresis at either a high level ( $10^{\circ}C$  for HYST =  $V_{DD}$ ) or a low level ( $5^{\circ}C$  for HYST = GND). Hysteresis prevents the output from chattering when the temperature is near the trip point. The HYST pin must not be left unconnected.

The output asserts when the temperature exceeds the trip point and deasserts when the temperature falls back below the trip point minus the hysteresis. For example, if the trip point is 105°C, the output will assert at 105°C and will not deassert until temperature falls below 105°C minus the hysteresis (e.g., 95°C if 10°C hysteresis is chosen) (Figure 2).

## \_Applications Information

### **Remote-Diode Selection**

To ensure best accuracy, use a good-quality diodeconnected transistor. Suggested devices are listed in Table 1. Large power transistors are not recommended. Tight specifications for forward current gain indicate the manufacturer has good process controls and that the devices have consistent V<sub>be</sub> characteristics. The MAX6513 can also measure the die temperature of CPUs and other integrated circuits having on-board temperature-sensing diodes. Use the monitor's output to reset the  $\mu$ P, assert an interrupt, activate a cooling fan, or trigger an external alarm.

### **Noise Filtering Capacitors**

A quality ceramic capacitor must be connected across the DXP/DXN inputs to maintain temperature threshold accuracy by filtering out noise. The capacitor should be located physically close to the DXP/DXN pins and should typically have a value of 2200pF. Larger capacitor values can cause temperature measurement errors. A 50% variation from the recommended capacitor value can cause up to  $\pm 1^{\circ}$ C error.



Figure 2. Temperature Trip Threshold Hysteresis

#### for TDFN Package **TEMPERATURE TRIP** DEVICE CODE THRESHOLD (°C) MAX6513TT045 +ACU 45 MAX6513TT055 +ACV 55 MAX6513TT065 +ACW 65 MAX6513TT075 +ACX 75 +ACY 85 MAX6513TT085 MAX6513TT095 +ACZ 95 105 MAX6513TT105 +ADA MAX6513TT115 +ADB 115 MAX6513TT125 +ADC 125

## Package Information

**Device Marking Codes** 

For the latest package outline information and land patterns (footprints), go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
6 TDFN-EP	T633+2	<u>21-0137</u>	<u>90-0058</u>

///XI/M

MAX6513

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	
2	10/04	Added the TDFN package to the <i>General Description</i> , <i>Features</i> , <i>Pin Configuration</i> , <i>Ordering Information</i> , and <i>Absolute Maximum Ratings</i> sections; added TDFN top mark codes to the <i>Device Marking Codes for SOT23-6 Package</i> table; added the TDFN package outline drawing	1, 2, 6, 8
3	3 2/11 Removed the MAX6511/MAX6512 parts and SOT23 packages from the data sheet; changed the leaded part to lead(Pb)-free in the <i>Ordering Information</i> table; in the <i>Absolute Maximum Ratings</i> section changed the continuous power dissipation numbers (24.4mW/°C to 18.2mW/°C and 1951mW to 1455mW), added the soldering temperature, and updated the lead temperature; added the exposed pad description to the <i>Pin Description</i> table; removed the top marks for SOT23-6 packages from the <i>Device Marking Codes for SOT23-6 Package</i> table and renamed the table; removed the <i>Chin Information</i> section; added the <i>Package Information</i> table		1–6

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**MAX6513**